



Representative Legal Matters

Alex Chiang

M&A and Direct Investment

- Carlyle's investment in Ta Chong Bank.
- Carlyle's proposed acquisition of Advanced Semi-conductor Engineering Inc.
- Oaktree's management buyout on Fu Sheng.
- Eaton's management buyout on Phoenixtec.
- Goldman Sachs PIA's investment in Taiwan Mobile.
- Lehman's investment in Data System.
- Nomura Securities's investment in preferred shares of Taishin Financial Holding Co., Ltd. at the amount of approximately USD140 million.
- Goldman's bid on the acquisition of CNS.
- Sinopac Holding's acquisition of International Bank of Taipei through 100% share swap.
- BenQ's acquisition of Siemens' mobile division.
- Joint Venture (an insurance company) between BNP and Taiwan Cooperative Bank.
- Tokio Marine's purchase of 30% Newa Insurance.
- Millea Holding's Purchase of 98% Allianz President General Insurance Company Ltd.
- Merger of Newa Insurance Co., Ltd. and Allianz President General Insurance Co., Ltd.
- Mitsui Sumitomo Insurance's purchase of 100% Mingtai Fire & Marine Insurance Co. Ltd. owned by First Financial Holding Co.
- AIG's acquisition of 100% Central Insurance Co., Ltd.
- Purchase of 100% of National Investment Trust Corporation by First Financial Holding Co., Ltd.
- Merger of Siliconware Precision Industries Co., Ltd. and Siliconware Corporation.
- Merger of UBS and SBC.

Baker McKenzie.

- Purchase of MMC's US subsidiary by Grand Pacific.
- Purchase of all assets of MBF's credit card company in Taiwan by Associates USA.
- Transfer of Kolin's factory, equipment and machinery to Malaysian company.
- Establishment of Sinopac Holdings (converted by Bank SinoPac and National Securities Corp.).

Capital Markets

- ADRs: Taiwan Semiconductor Manufacturing Company Ltd., Siliconware Precision Industries Co., Ltd., AU Optronics Corp.
- GDRs: Gintech Solar Co., Ltd., Cathay Financial Holding Co., Ltd., Powertech Technologies Co., Ltd., ProMOS Technologies Inc., Advanced Semiconductor Engineering Inc., Acer Incorporated, Walsin Lihwa Corp., CMC Magnetics Corporation.
- ECBs: E-Ton Solar, Cathay Financial Holding Co., Ltd., Sinopac Holdings, Siliconware Precision Industries Co., Ltd., ProMOS Technologies Inc., CMC Magnetics Corporation, Stark Technology Inc., Winbond Electronics Corp., Acer Peripheral, Inc., Lead Data Inc., Behavior Tech Computer Corp., Cheil Technology Corp.
- NASDAQ Listing: ChipMOS Technologies Inc.
- Singapore Listing: Chailease.
- Dragon Bonds: Asian Development Bank.
- Syndication Loan.
- Syndication Loan: ProMOS Technologies Inc., ChipMOS Technologies Inc., Taiwan Broadband Communications, Co., Ltd.
- Project Finance: Ever Power IPP Co., Ltd., Hsin Tao Power Corp.
- NIF: CMC Magnetics Corp., Capital Securities Corp., Jin Sun Securities Co., Ltd.

Insurance

- General and regulatory insurance advice to Cathay Life Insurance Co., Ltd., Shin Kong Life Insurance Co., Ltd., Newa Insurance Co., Ltd., Allianz President General Insurance Co., Ltd. and Mass Mutual Life.

Securitization

- Collateralized loan obligation deal arranged by Credit Lyonnais (First CLO deal through public offering in Taiwan).



- Collateralized loan obligation deal arranged by China Development Industrial Bank.
- Collateralized bond obligation deal arranged by ABN AMRO and Citibank with E Sun Bank as originator.
- REITs of Shin Kong Life Insurance Co., Ltd.
- REITs of Cathay Life Insurance Co., Ltd.
- REATs of Shin Kong Life Insurance Co., Ltd.